

Title: Migrating from MX25L3255D to MX25L3255E, and Discontinuance of MX25L3255D

Notification Number: P-1207-0004

Notification Date: August 1, 2012

Change Type: Product Migration and Discontinuance

1. Change Identification

Product Identification	MX25L3255D
Reason of Change	Migration to new products and discontinuance of former products

2. Implementation Schedule

2-a. Affected Product Schedule

Last Order Date	April 30, 2013
Last Ship Date	July 31, 2013

2-b. Replacement Product Schedule

Sample Availability	Available
----------------------------	-----------

3. List of Product Affected

Affected Part Number		Recommend Part Number
MX25L3255DM2I-10G	➔	MX25L3255EM2I-10G
MX25L3255DXCI-10G		MX25L3255EXCI-10G

Should you have any questions or specific requirement for the extension of product supports, please contact your local Macronix sales representative within 30 days. For other information or specification of succeeding products, please contact your local Macronix sales representative or visit Macronix's Web site at <http://www.macronix.com>.

4. Supplementary

Additional Comments	
Reference Documents	Migration guide (AN174): Migrating from MX25L3255D to MX25L3255E

Major Differences:

Feature		MX25L3255E	MX25L3255D
Voltage		2.7~3.6 V	2.7~3.6 V
Interface		x1, x2, x4	x1, x2, x4
Package		24-TFBGA (6x8mm) 8-SOP (209mil)	24-TFBGA (6x8mm) 8-SOP (209mil)
Operation Temperature		-40~85°C	-40~85°C
Sector / Block		4KB / 32KB or 64KB	4KB / 64KB
Clock Rate (max.)	Normal Read	50MHz	33MHz
	1 I/O	104MHz	104MHz
	2 I/O	86MHz	75MHz
	4 I/O	104MHz	75MHz
Configurable Dummy Cycle		Yes, for 4READ mode only	No
CP Mode		Yes	Yes
Data Protection	Security OTP	4Kbits	4Kbits
	Block Protection	BP3~BP0	No
	T/B (Top/Bottom) Bit	Yes	No
	Single Block Protection	Yes, SRAM bit	Yes, NVM bit
	Permanent Lock Protection	Yes	Yes
	Permanent Lock Bit Lock-Down	Yes	No
	Read Lock Protection	Yes	Yes
SFDP		Yes	No
HOLD#		Yes	No

Comments:

The information contented herein is provided based on the current product status. Macronix reserves the right to change product and specifications, or to make correction or modification to the document without notice. Unless otherwise agreed by Macronix in writing, Macronix shall assume no liability or responsibility for any damage or loss arising out of or in connection with this notice and/or the product change contemplated herein.

Except for customized products which have been expressly identified in the applicable agreement, Macronix's products are designed, developed, and/or manufactured for ordinary business, industrial, personal, and/or household applications only, and not for use in any applications which may, directly or indirectly, cause death, personal injury, or severe property damages. In the event Macronix products are used in contradicted to their target usage above, the buyer shall take any and all actions to ensure said Macronix's product qualified for its actual use in accordance with the applicable laws and regulations; and Macronix as well as it's suppliers and/or distributors shall be released from any and all liability arisen therefrom.

Copyright© Macronix International Co., Ltd. 2012. All rights reserved, including the trademarks and tradename thereof, such as Macronix, MXIC, MXIC Logo, MX Logo, Integrated Solutions Provider, NBit, Nbit, NBit, Macronix NBit, eLiteFlash, HybridNVM, HybridFlash, XtraROM, Phines, KH Logo, BE-SONOS, KSMC, Kingtech, MXSMIO, Macronix vEE, Macronix MAP, Rich Au-dio, Rich Book, Rich TV, and FitCAM. The names and brands of third party referred thereto (if any) are for identification purposes only.